Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)

Contact Info: <u>ti.com/support</u>

Form/Declaration Type: Distribute - RoHS and IEC 62474 DB

Created on: **06/10/2022**

Details for "TPS3823A-33DBVR"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
TPS3823A-33DBVR	NIPDAU	Level-1-260C-UNLIM	Ext-Mfg	DBV 5	2.9x1.6x1.45	18.4

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB	
Yes	Yes	Yes	Yes	

Component Information

				Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire	•	•		•		•	
Precious Metals	Gold	7440-57-5	0.030503	100	1000000	0.165618	1656
Sub-Total			0.030503	100	1000000	0.165618	1656
Die Attach Adhesive	•						
Precious Metals	Silver	7440-22-4	0.204947	79.999922	799999	1.112773	11128
Thermoplastics	Ероху	85954-11-6	0.051237	20.000078	200001	0.278195	2782
Sub-Total			0.256184	100	1000000	1.390968	13910
Lead Frame				_			
Copper and Its Alloys	Copper	7440-50-8	6.290748	97.38	973800	34.156036	341560
Copper and Its Alloys	Iron	7439-89-6	0.153748	2.38	23800	0.834785	8348
Copper and Its Alloys	Phosphorus	7723-14-0	0.005426	0.083994	840	0.029461	295
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.001938	0.03	300	0.010523	105
Zinc and Its Alloys	Zinc	7440-66-6	0.00814	0.126006	1260	0.044197	442
Sub-Total			6.46	100	1000000	35.075001	350750
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.110339	95.119828	951198	0.599093	5991
Precious Metals	Gold	7440-57-5	0.000905	0.780172	7802	0.004914	49
Precious Metals	Palladium	7440-05-3	0.004756	4.1	41000	0.025823	258
Sub-Total			0.116	100	1000000	0.62983	6298
Mold Compound		_		_			
Other Inorganic Materials	Fused Silica	60676-86-0	9.269733	85.999994	860000	50.330633	503306
Other Plastics and Rubber	Carbon Black	1333-86-4	0.053894	0.500002	5000	0.292621	2926
Thermoplastics	Ероху	85954-11-6	1.455133	13.500004	135000	7.900742	79007
Sub-Total			10.77876	100	1000000	58.523996	585240
Semiconductor Device	•			-			
Ceramics / Glass	Doped Silicon	7440-21-3	0.776229	100	1000000	4.214587	42146
Sub-Total			0.776229	100	1000000	4.214587	42146
Total			18.417676			100	1000000

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The page calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the substance within the component level and are average concentration values.

The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**. See Glossary of Terms for more details.

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/10/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.